



國立清華大學
NATIONAL TSING HUA UNIVERSITY

Colloquium

Department of Engineering and
System Science,
Institute of Nuclear Engineering
and Science,
National Tsing Hua University

The On-Wafer Turnkey Testing Technologies

**Taylor Hsiao, General Manager,
POMME TECHNOLOGIES CO.,
LTD**

POMME's core value is providing the right **on-wafer** electrical testing package system (software/hardware/equipment) for all kind of testing needed clients. Our solution cover foundry industry, bumping industry, LCD industry, LED, LD(EO/OE), IC package, MEMS industry, RF testing.



禧恩科技股份有限公司
POMME TECHNOLOGIES CO., LTD



15:30-17:00 P.M., Wednesday, Nov. 18th, 2020

NE69 ESS Building, NTHU

101, Sec2, Kaung-Fu Rd., Hsinchu 30013, Taiwan

Biography:



Taylor Hsiao is currently General Manager of POMME Technologies CO., LTD, Located at Zubei. He received his Master degree in MEMS, ESS from National Tsing Hua University in 2006, and subsequently joined Winbond/ Agilent as solution provider for wafer process electrical monitor solution design. Joint venture of Raytrex Technologies as the turnkey application consultant for FPD and foundry industry for 8 years and turn to build up POMME as a "testing solution design house" to provide the new build up design house highly integrated and cost efficient testing and probing package system.

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